

MSE20N06N

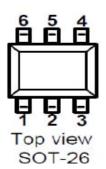
Dual N-Channel 20-V (D-S) MOSFET

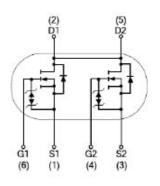
FEATURES

- Low RDS(on) trench technology
- Low thermal impedance
- · Fast switching speed

Typical Applications:

- Battery Powered Instruments
- Portable Computing
- Mobile Phones
- •GPS Units and Media Players









ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}$ C UNLESS OTHERWISE NOTED)							
Parameter			Limit	Units			
Drain-Source Voltage		V _{DS}	20	V			
Gate-Source Voltage		V_{GS}	±8	V			
Continuous Drain Current ^a	T _A =25°C	I_	6				
Continuous Drain Current	T _A =100°C	I _D	3.6	Α			
Pulsed Drain Current ^b		I_{DM}	22				
Continuous Source Current (Diode Conduction) a		Is	1	Α			
Davier Discipation ⁸	T _A =25°C	ь	0.83	W			
Power Dissipation ^a	T _A =100°C	P_D	0.3	٧٧			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Maximum	Units			
Maximum Junction-to-Ambient ^a	t <= 10 sec	$R_{\theta JA}$	110	°C/W			
	Steady State	IN⊕JA	150	C/VV			

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature



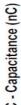
Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit		
Static								
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, ID = 250 uA	20			V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			±10	uA		
Zero Gate Voltage Drain Current	lass	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA		
	I _{DSS}	V_{DS} = 16 V, V_{GS} = 0 V, T_{J} = 85°C			30			
On-State Drain Current	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α		
Drain-Source On-Resistance		$V_{GS} = 4.5 \text{ V}, I_{D} = 6 \text{ A}$			20	mΩ		
	r _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_{D} = 5 \text{ A}$			28			
Forward Transconductance	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 6 \text{ A}$		10		S		
Diode Forward Voltage	V _{SD}	$I_{S} = 1.0 \text{ A}, V_{GS} = 0 \text{ V}$		0.7		V		
Dynamic								
Total Gate Charge	Q_g	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6 \text{ A}$		13.5		nC		
Gate-Source Charge	Q_{gs}			0.9				
Gate-Drain Charge	Q_{gd}			5.4				
Turn-On Delay Time	t _{d(on)}			6				
Rise Time	t_r	V_{DD} = 10 V, R _L = 10 Ω , I _D = 1 A, V_{GEN} = 4.5 V, R _{GEN} = 6 Ω		12		ns		
Turn-Off Delay Time	t _{d(off)}			65				
Fall Time	t _f			35				
Input Capacitance	C _{iss}			680				
Output Capacitance	Coss	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		144		pF		
Reverse Transfer Capacitance	C _{rss}			137				

Notes

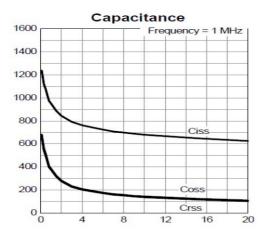
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

Characteristic Curves



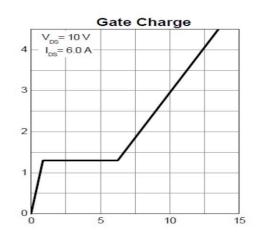
I_D - Drain Current (A)



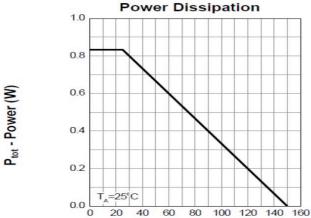


V_{DS} - Drain-Source Voltage (V)

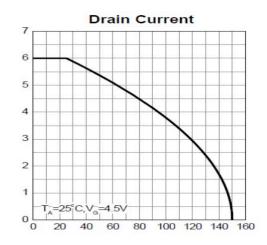




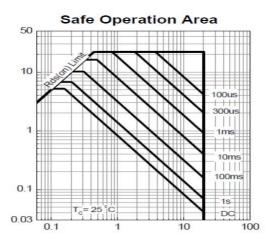
Q_G - Gate Charge (nC)



T_j - Junction Temperature (°C)



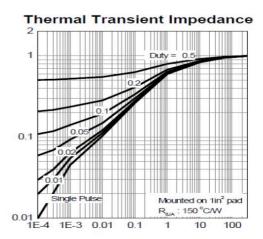
T_j - Junction Temperature (°C)



V_{DS} - Drain-Source Voltage (V)



I_D - Drain Current (A)



Square Wave Pulse Duration (sec)